IN THE SPECIFICATION:

Change the title to read

PROCESS FOR MAKING A CERAMIC COMPOSITE DEVICE

In the paragraph after the title referring to the parent applications, please change this paragraph to read:

This application is a division of US Application Serial No. 09/592,190, filed June 12, 2000, now U.S. Patent No. 6,703,153, issued March 9, 2004, which is division of US Application Serial No. 09/020,204, filed February 6, 1998, now U.S. Patent No. 6,074,771, issued June 13, 2000.

Page 4, lines 23 and 24, change the paragraph to read as follows:

Figure 13 is a Figures 13A, 13B and 13C comprise a series of partial, schematic, exploded view views of the components of a fluid fuel embodiment of the ceramic composite cell of the device of the present invention showing these components in an unassembled condition (Fig. 13A), a partially assembled condition (Fig. 13B), and an assembled condition (Fig. 13C).

Page 6, between lines 17 and 18, please add the following paragraph:

Figure 26G is a cut-away view taken along line B-B of Figure 26E.

Page 8, lines 18-28, change the paragraph to read as follows:

Turning first to a discussion of the preferred embodiment of the ceramic composite cells 12, components of which are illustrated in Figures 2 to 15, the cells of the embodiments of the present device include the following components: a bipolar foil 50, preferably having an

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embossed three dimensional, two direction dimple pattern 52 as illustrated in Figures 5, 6, 9 and 10, which supports an electrical contact layer 112; a frame 54 54 having optional opposite first and second frame members 56, 58 secured together to surround, support and engage components of the cell, one of these frame members being shown at 56 in Figs. 13A and 13B; a photolithographic foil member 60, 60' (Figures 11, 12) preferably having a hole pattern which is typically hexagonal close packed, or honeycomb, is illustrated in Figure 12A and supports the preferred ceramic material; and an optional cell heat element 62, which may include a layer of insulation 63 191, is illustrated in Figures 17-17B.